ANG<mark>SEMI</mark>

Magnetic Sensor IC

South Unipolar Detection High Performance Low Power Hall-Effect Sensor IC

General Description

Using low power CMOS process, the AS1812 is designed for low power, high performance unipolar detection hall-effect application, such as cover switch, contactless switch, solid state switch and lid close sensor etc battery operation. The hall IC integrated an on-chip hall voltage generator for magnetic sensing, a comparator that amplifiers the hall voltage, a Chopper amplifier, a Schmitt trigger to provide switching hysteresis for noise rejection, and a complementary output.

The total power consumption of AS1812 is typically 0.6uA at 1.8V power supply. AS1812 is designed to respond to alternating South pole. When the magnetic flux density (B) is larger than operate point (B_{OPS}), the output will be turned on (low), the output is held until the magnetic flux density (B) is lower than release point (B_{RPS}), then turn off (high).

The device is available inDFN1216-4L,SOT553 and SIP-3L Packageand is rated over the -40°C to 85°C. The package is RoHS and Green compliant.

Datasheet



AS1812

Features

- Input VoltageRange: 1.65V to 5.0V
- Micro-power consumption ideal for battery power applications
- Uniplar Operation, easy to use as output
- Very high sensitivity hall sensor
- Low Power CMOS process technology
- Chopper stabilization amplifier stageMagnetic Sensitivity (typical)
 - B_{OPS}=30Gauss, B_{RPS}=20Gauss
- Good RF noise immunity
- No need pull-up resistor
- Small Solution Size
- RoHS & Green Compliant
- DFN1216-4L and SOT553 Package
- -40°C to +85 °C Temperature Range

Applications

- Cover switch in clam-shell cellular phones
- Cover switch in Notebook, PC/PAD
- Contact-less switch in consumer products
- Solid State Switch
- Handheld Wireless Handset Awake Switch
- Lid close sensor for battery-powered devise
- Magnet proximity sensor for reed switch replacement in low duty cycle applications
- DV, DSC, and White Goods

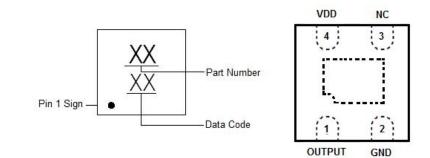
Ordering Information

		AS18	812XXX ⊺⊺ ⊑				
│ │ │ │ Package: Packing: Temperature Grade: D4:DFN1216-4L R:Tape&Reel N: -40°C~85°C W: SOT553 B: Bulk M: SIP-3L							
Part Number	B _{OPS} (Gauss)	B _{RPS} Gauss)	Package Type	Package Qty	Temperature	Eco Plan	Lead
AS1812D4RN	30	20	DFN1216-4L	7-in reel 3000pcs/reel	-40∼85 ℃	Green	Cu
AS1812WRN	30	20	SOT553	7-in reel 3000pcs/reel	-40∼85 ℃	Green	Cu



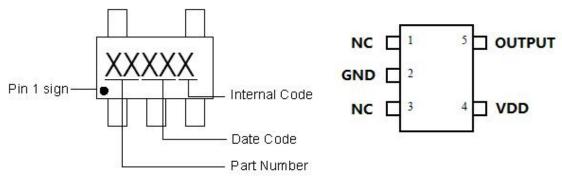
Marking & Pin Assignment

DFN1216-4L



Pin Name	Pin No. DFN1216-4L	I/O	Pin Function
VDD	4	Р	Input Power Supply
GND	2	Р	Ground
NC	3	-	Not Connected
OUTPUT	1	0	Output Pin

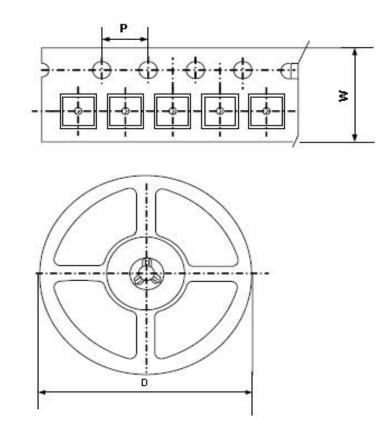
SOT553:



Pin Name	Pin No.	1/0	Pin Function	
	SOT553			
VDD	4	Р	Input Power Supply	
GND	2	P	Ground	
NC	1, 3	-	Not Connected	
OUTPU	- 5	0	Output Pin	

Packing Information

DFN1216-4L/SOT553:



Package Type	Carrier Width(W)	Pitch(P)	Reel Size(D)	Packing Minimum
DFN1216-4L	8.0±0.1 mm	4.0±0.1 mm	180±1 mm	3000pcs
SOT553	8.0±0.1 mm	4.0±0.1 mm	180±1 mm	3000pcs

Note: Carrier Tape Dimension, Reel Size and Packing Minimum